

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a leadless medium power DFN2020MD-6 (SOT1220) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Extended temperature range T_i = 175 °C
- Side wettable flanks for optical solder inspection
- Small and leadless ultra thin SMD plastic package: 2 x 2 x 0.65 mm
- Trench MOSFET technology
- AEC-Q101 qualified

3. Applications

- Relay driver
- High-speed line driver
- High-side load switch
- Switching circuits

4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-60	V
V _{GS}	gate-source voltage	-		-20	-	20	V
I _D	drain current	V _{GS} = -10 V; T _{sp} = 25 °C		-	-	-8	А
P _{tot}	total power dissipation	T _{sp} = 25 °C		-	-	15	W
Static chara	acteristics	- -	·				,
R _{DSon}	drain-source on-state resistance	V _{GS} = -10 V; I _D = -3 A; T _j = 25 °C		-	95	120	mΩ

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5. Pinning information

Table	2.	Pinning	information
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Pin	Symbol	Description	Simplified outline	Graphic symbol
1	D	drain		D
2	D	drain		
3	G	gate		G-UF
4	S	source		S
5	D	drain	Transparent top view	017aaa094
6	D	drain	DFN2020MD-6 (SOT1220)	
7	D	drain		
8	S	source		

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BUK6D120-60P	DFN2020MD-6	DFN2020MD-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals	SOT1220		

7. Marking

Table 4. Marking codes

Type number	Marking code
BUK6D120-60P	4S

8. Limiting values

Table 5. Limiting values

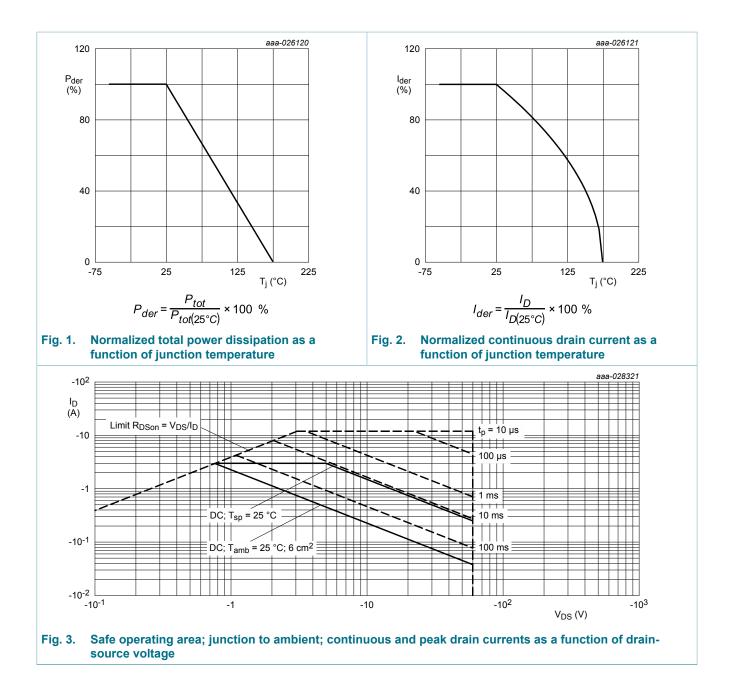
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-60	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = -10 V; T _{sp} = 25 °C		-	-8	А
		V _{GS} = -10 V; T _{sp} = 100 °C		-	-5.1	А
		V _{GS} = -10 V; T _{amb} = 25 °C	[1]	-	-3	А
I _{DM}	peak drain current	T_{sp} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-32	А
P _{tot}	total power dissipation	T _{sp} = 25 °C		-	15	W
		T _{amb} = 25 °C	[1]	-	2.3	W
Tj	junction temperature			-55	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C
Source-drai	n diode		·	·		
I _S	source current	T _{sp} = 25 °C		-	-8	А
		T _{amb} = 25 °C	[1]	-	-2.3	А
I _{SM}	peak source current	single pulse; $t_p \le 10 \ \mu s$; $T_{sp} = 25 \ ^{\circ}C$		-	-32	А
ESD maxim	um rating		·	·		
V _{ESD}	electrostatic discharge voltage	НВМ	[2]	-	500	V
Avalanche r	uggedness					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$T_{j(init)}$ = 25 °C; I_D = -0.85 A; DUT in avalanche (unclamped)		-	28	mJ
					1	

Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 $\rm cm^2.$ Measured between all pins. [1] [2]

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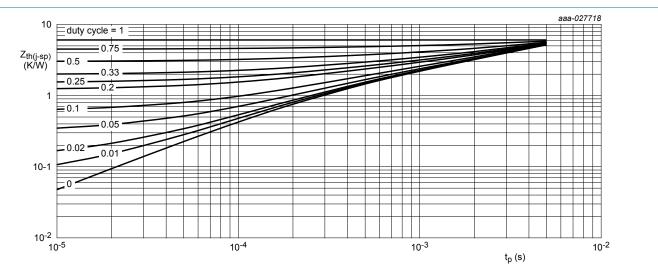


9. Thermal characteristics

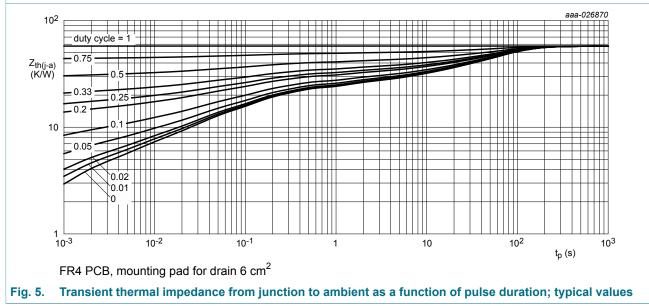
Table 0. Therma	al characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	57	66	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	6	10	K/W

Table 6 Thormal characteristics

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².







10. Characteristics

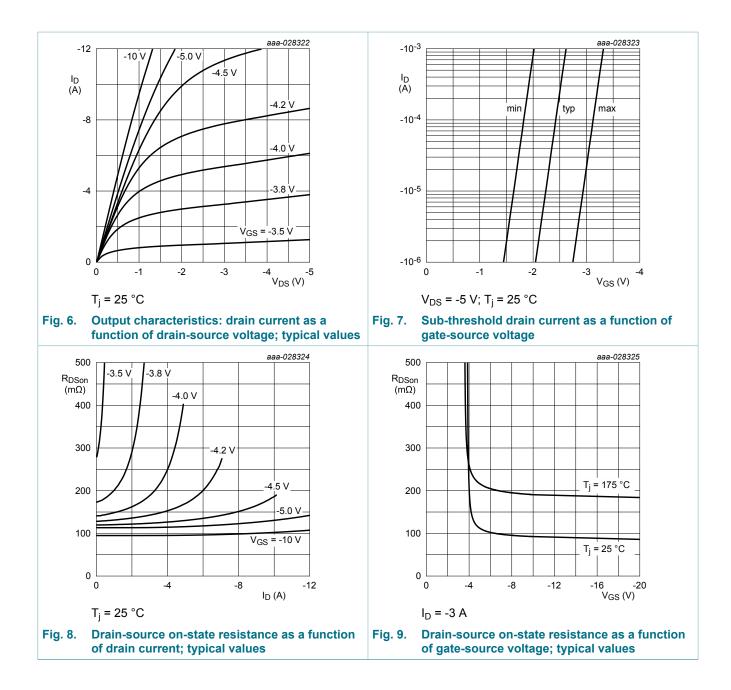
Table 7. Characteristics

 T_i = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics		1			
V _{(BR)DSS}	drain-source breakdown voltage	I _D = -250 μA; V _{GS} = 0 V	-60	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-1.9	-2.5	-3.2	V
I _{DSS}	drain leakage current	V_{DS} = -60 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-1	μA
		V_{DS} = -60 V; V_{GS} = 0 V; T_j = 175 °C	-	-	-500	μA
I _{GSS}	gate leakage current	V _{GS} = -20 V; V _{DS} = 0 V	-	-	-100	nA
		V _{GS} = 20 V; V _{DS} = 0 V	-	-	100	nA
R _{DSon}	drain-source on-state	V _{GS} = -10 V; I _D = -3 A; T _j = 25 °C	-	95	120	mΩ
	resistance	V _{GS} = -10 V; I _D = -3 A; T _j = 175 °C	-	202	256	mΩ
		V_{GS} = -4.5 V; I _D = -2.5 A	-	125	170	mΩ
9 _{fs}	forward transconductance	V _{DS} = -10 V; I _D = -3 A	-	13	-	S
R _G	gate resistance	f = 1 MHz	-	8	-	Ω
Dynamic ch	naracteristics		·			
Q _{G(tot)}	total gate charge	V_{DS} = -30 V; I _D = -3 A; V _{GS} = -10 V	-	12	18	nC
Q _{GS}	gate-source charge	V _{DS} = -30 V; I _D = -3 A; V _{GS} = -10 V	-	2.6	-	nC
Q _{GD}	gate-drain charge		-	2.6	-	nC
C _{iss}	input capacitance	V_{DS} = -30 V; f = 1 MHz; V_{GS} = 0 V	-	724	-	pF
C _{oss}	output capacitance		-	55	-	pF
C _{rss}	reverse transfer capacitance		-	30	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -30 V; I _D = -3 A; V _{GS} = -10 V;	-	9	-	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega$	-	10	-	ns
t _{d(off)}	turn-off delay time		-	24	-	ns
t _f	fall time]	-	18	-	ns
Source-drai	in diode					
V _{SD}	source-drain voltage	$I_{\rm S}$ = -2.3 A; $V_{\rm GS}$ = 0 V	-	-0.8	-1.2	V
t _{rr}	reverse recovery time	$I_{S} = -2.3 \text{ A}; \text{ dI}_{S}/\text{dt} = 100 \text{ A}/\mu\text{s};$	-	24	-	ns
Q _r	recovered charge	V _{GS} = 0 V; V _{DS} = -30 V; T _j = 25 °C	-	24	-	nC

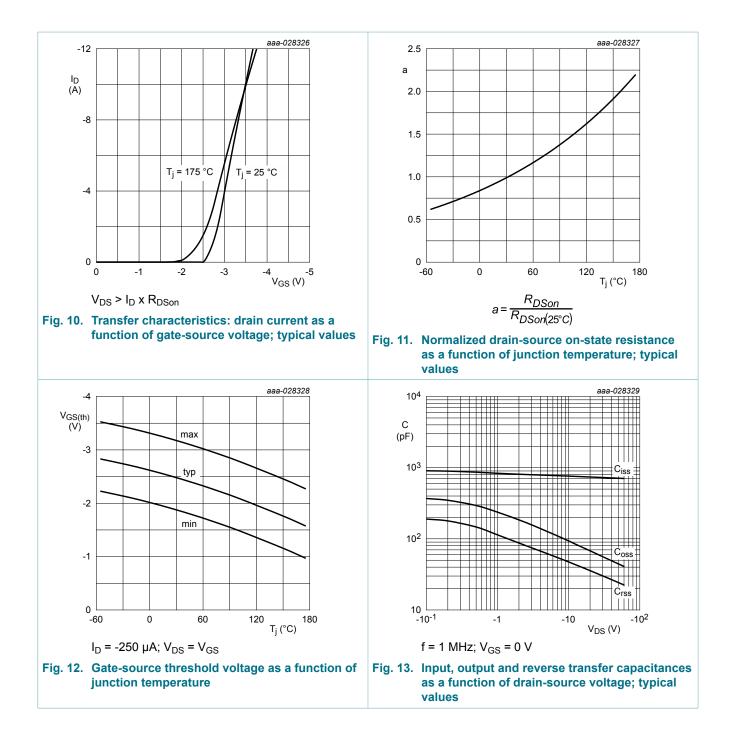
BUK6D120-60P

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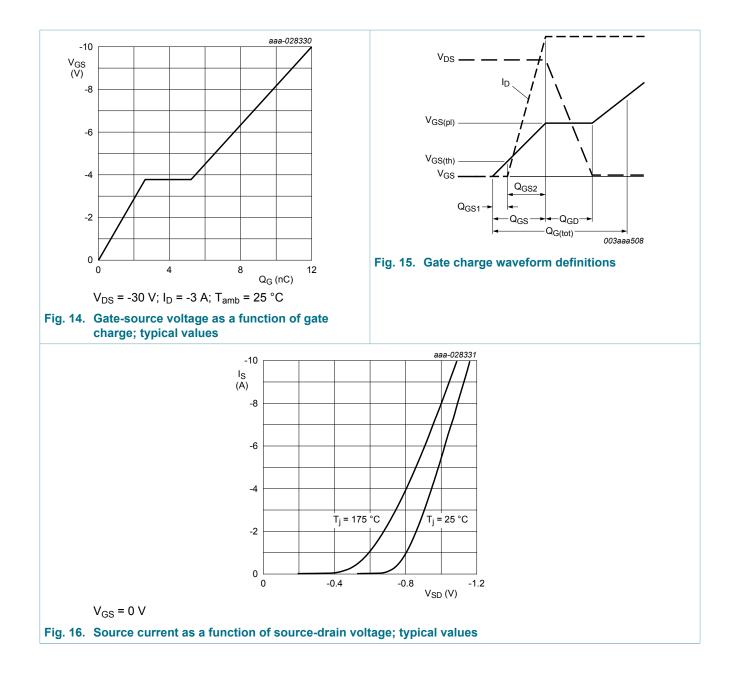
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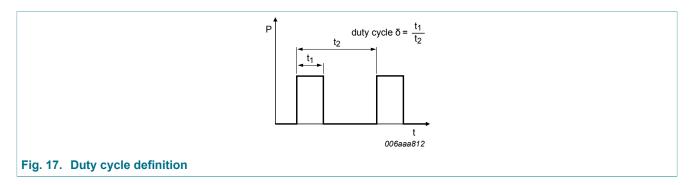


BUK6D120-60P

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11. Test information



Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

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12. Package outline

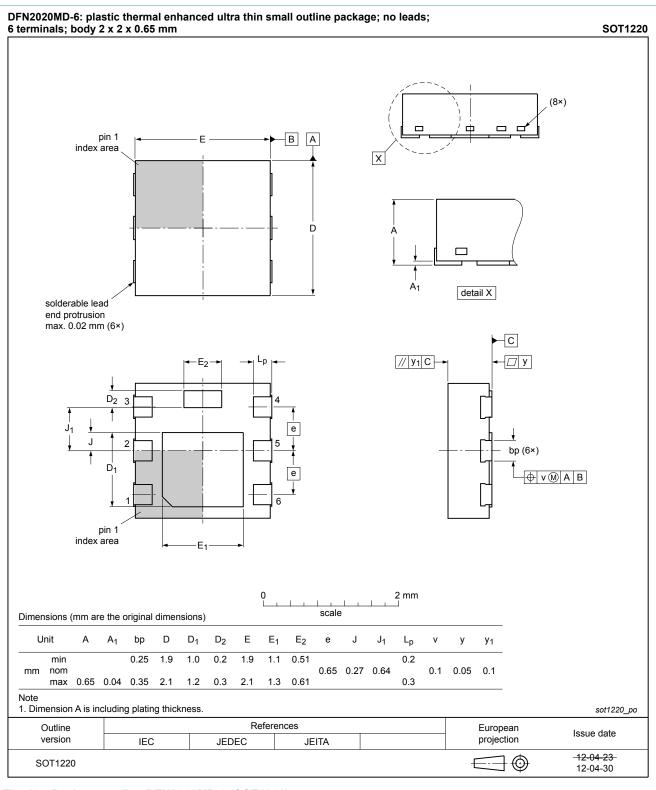
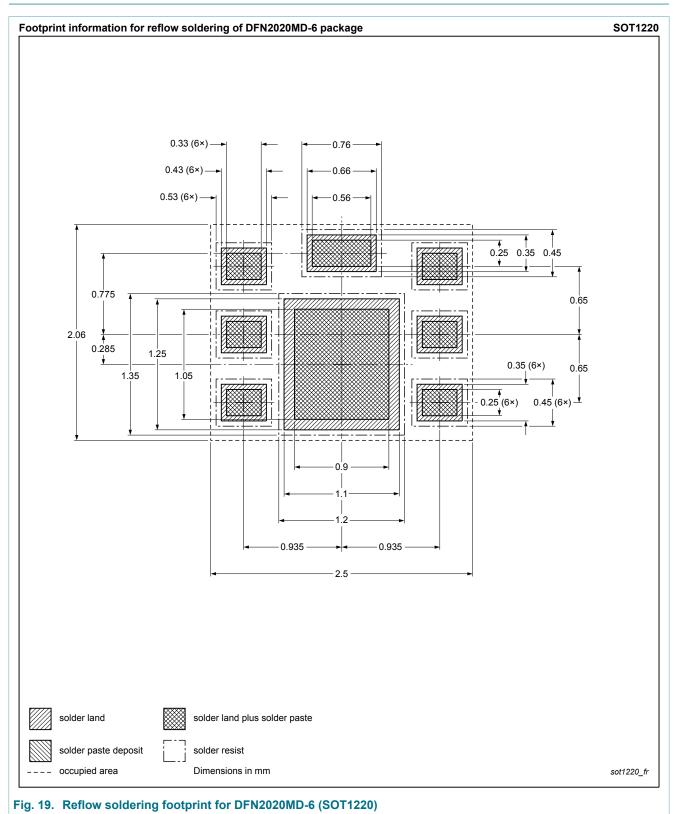


Fig. 18. Package outline DFN2020MD-6 (SOT1220)

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13. Soldering



14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
BUK6D120-60P v.1	20180403	Product data sheet	-	-		

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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